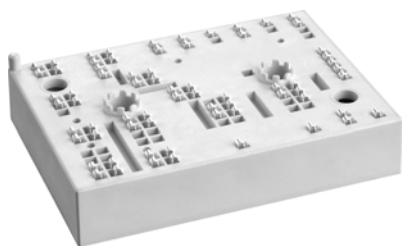


SKiiP 37AC12T4V1



MiniSKiiP® 3

SKiiP 37AC12T4V1

Features

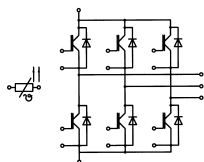
- Trench 4 IGBT's
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised file no. E63532

Typical Applications*

- Inverter up to 36 kVA
- Typical motor power 22 kW

Remarks

- V_{CEsat} , V_F = chip level value
- Case temp. limited to $T_C = 125^\circ\text{C}$ max. (for baseplateless modules $T_C = T_S$)
- product rel. results valid for $T_j \leq 150$ (recomm. Top = $-40 \dots +150^\circ\text{C}$)



AC

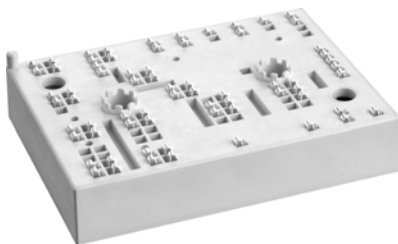
Absolute Maximum Ratings

Symbol	Conditions		Values	Unit
Inverter - IGBT				
V _{CES}	T _j = 25 °C		1200	V
I _C	T _j = 175 °C	T _s = 25 °C	90	A
		T _s = 70 °C	73	A
I _{Cnom}			75	A
I _{CRM}	I _{CRM} = 3 x I _{Cnom}		225	A
V _{GES}			-20 ... 20	V
t _{psc}	V _{CC} = 800 V V _{GE} ≤ 15 V V _{CES} ≤ 1200 V	T _j = 150 °C	10	μs
T _j			-40 ... 175	°C
Inverse - Diode				
I _F	T _j = 175 °C	T _s = 25 °C	83	A
		T _s = 70 °C	66	A
I _{Fnom}			75	A
I _{FRM}	I _{FRM} = 3 x I _{Fnom}		225	A
I _{FSM}	10 ms, sin 180°, T _j = 150 °C		430	A
T _j			-40 ... 175	°C
Module				
I _{t(RMS)}	T _{terminal} = 80 °C, 20A per spring		160	A
T _{stg}			-40 ... 125	°C
V _{isol}	AC sinus 50Hz, t = 1 min		2500	V

Characteristics

Symbol	Conditions		min.	typ.	max.	Unit
Inverter - IGBT						
V _{CE(sat)}	I _C = 75 A	T _j = 25 °C		1.85	2.10	V
	V _{GE} = 15 V chiplevel	T _j = 150 °C		2.25	2.45	V
V _{CE0}		T _j = 25 °C		0.8	0.9	V
		T _j = 150 °C		0.7	0.8	V
r _{CE}	V _{GE} = 15 V	T _j = 25 °C		14	16	mΩ
		T _j = 150 °C		21	22	mΩ
V _{GE(th)}	V _{GE} = V _{CE} , I _C = 3 mA		5	5.8	6.5	V
I _{CES}	V _{GE} = 0 V	T _j = 25 °C		0.1	0.3	mA
	V _{CE} = 1200 V					mA
C _{ies}	V _{CE} = 25 V	f = 1 MHz		4.40		nF
C _{oes}	V _{GE} = 0 V	f = 1 MHz		0.29		nF
C _{res}		f = 1 MHz		0.23		nF
Q _G	- 8 V...+ 15 V			425		nC
R _{Gint}	T _j = 25 °C			10.00		Ω
t _{d(on)}	V _{CC} = 600 V	T _j = 150 °C		145		ns
t _r	I _C = 75 A	T _j = 150 °C		45		ns
E _{on}	R _{G on} = 1 Ω	T _j = 150 °C		11.5		mJ
t _{d(off)}	R _{G off} = 1 Ω	T _j = 150 °C		350		ns
t _f	di/dt _{on} = 1560 A/μs	T _j = 150 °C		65		ns
E _{off}	di/dt _{off} = 1180 A/μs	T _j = 150 °C		6.8		mJ
	V _{GE} = +15/-15 V	T _j = 150 °C				
R _{th(j-s)}	per IGBT			0.58		K/W

SKiiP 37AC12T4V1



MiniSKiiP® 3

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Features

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- UL recognised file no. E63532

Typical Applications*

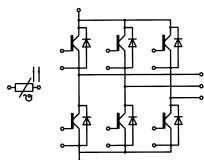
- Inverter up to 36 kVA
- Typical motor power 22 kW

Remarks

- V_{CEsat} , V_F = chip level value
- Case temp. limited to $T_C = 125^\circ\text{C}$ max. (for baseplateless modules $T_C = T_S$)
- product rel. results valid for $T_j \leq 150$ (recomm. Top = $-40 \dots +150^\circ\text{C}$)

Characteristics

Symbol	Conditions		min.	typ.	max.	Unit
Inverse - Diode						
$V_F = V_{EC}$	$I_F = 75 \text{ A}$ $V_{GE} = 0 \text{ V}$ chiplevel	$T_j = 25^\circ\text{C}$		2.2	2.5	V
		$T_j = 150^\circ\text{C}$		2.1	2.4	V
V_{F0}		$T_j = 25^\circ\text{C}$		1.3	1.5	V
		$T_j = 150^\circ\text{C}$		0.9	1.1	V
r_F		$T_j = 25^\circ\text{C}$		12	13	m Ω
		$T_j = 150^\circ\text{C}$		16	18	m Ω
I_{RRM}	$I_F = 75 \text{ A}$	$T_j = 150^\circ\text{C}$		99		A
Q_{rr}	$di/dt_{off} = 2440 \text{ A}/\mu\text{s}$ $V_{GE} = -15 \text{ V}$	$T_j = 150^\circ\text{C}$		13.3		μC
E_{rr}	$V_{CC} = 600 \text{ V}$	$T_j = 150^\circ\text{C}$		5.5		mJ
$R_{th(j-s)}$	per Diode			0.75		K/W
Module						
M_s	to heat sink		2		2.5	Nm
w				95		g
Temperatur Sensor						
R_{100}	$T_C = 100^\circ\text{C}$ ($R_{25} = 1000\Omega$)			$1670 \pm 3\%$		Ω
$R(T)$	$R(T) = 1000\Omega [1 + A(T - 25^\circ\text{C}) + B(T - 25^\circ\text{C})^2]$], $A = 7.635 \cdot 10^{-3} \text{ }^\circ\text{C}^{-1}$, $B = 1.731 \cdot 10^{-5} \text{ }^\circ\text{C}^{-2}$					



AC

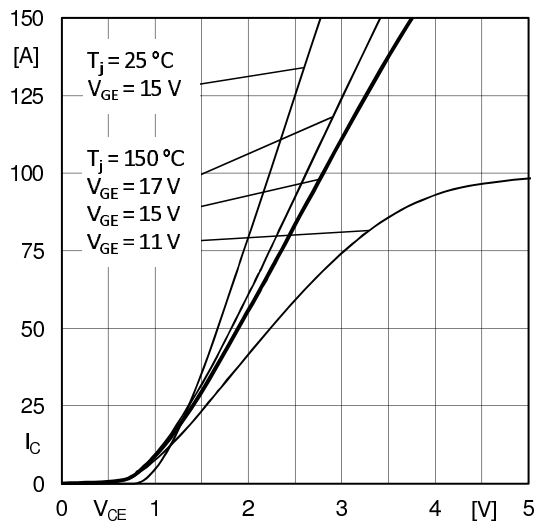


Fig. 1: Typ. output characteristic, inclusive $R_{CC'} + E_{E'}$

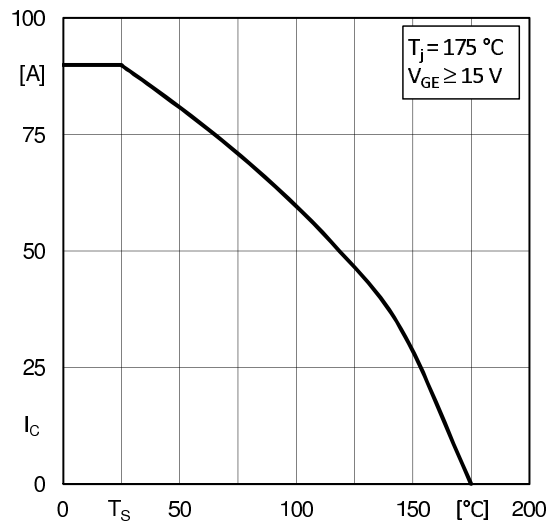


Fig. 2: Rated current vs. temperature $I_C = f(T_s)$

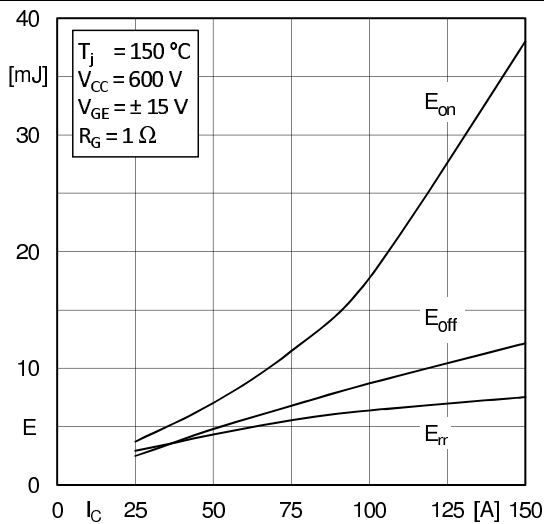


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

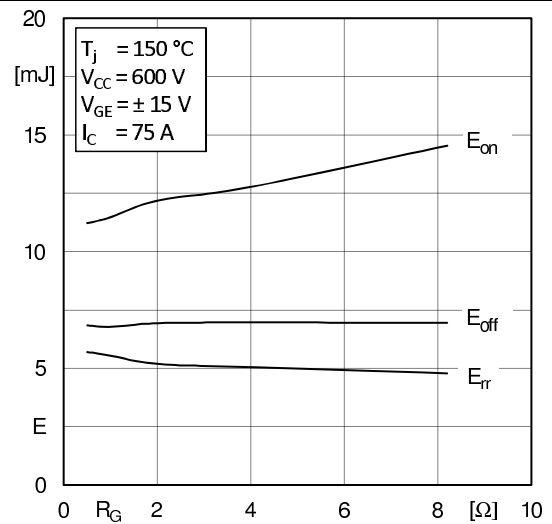


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

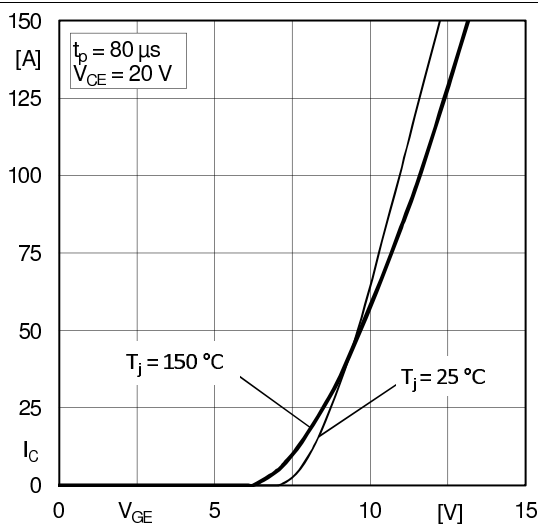


Fig. 5: Typ. transfer characteristic

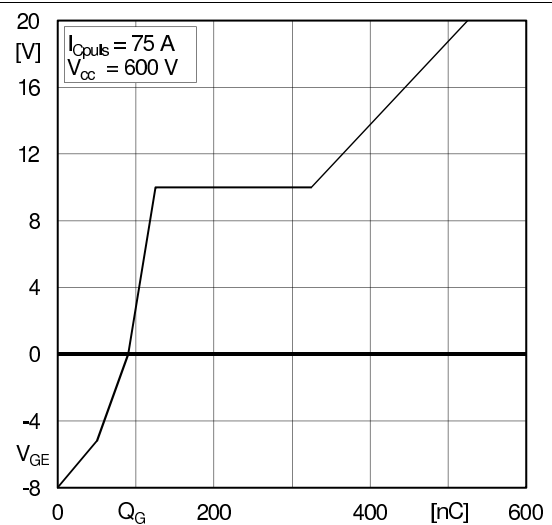


Fig. 6: Typ. gate charge characteristic

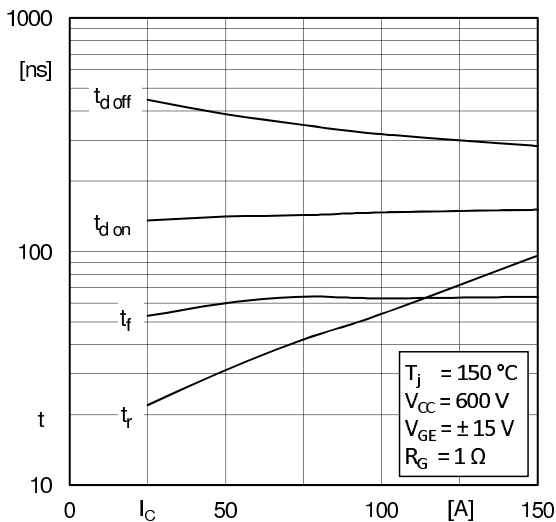


Fig. 7: Typ. switching times vs. I_C

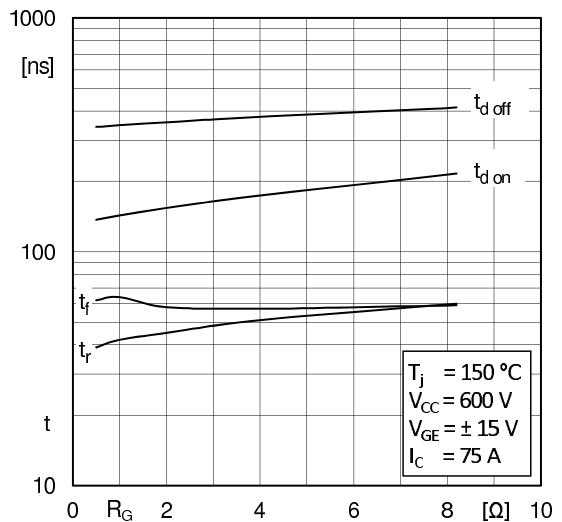


Fig. 8: Typ. switching times vs. gate resistor R_G

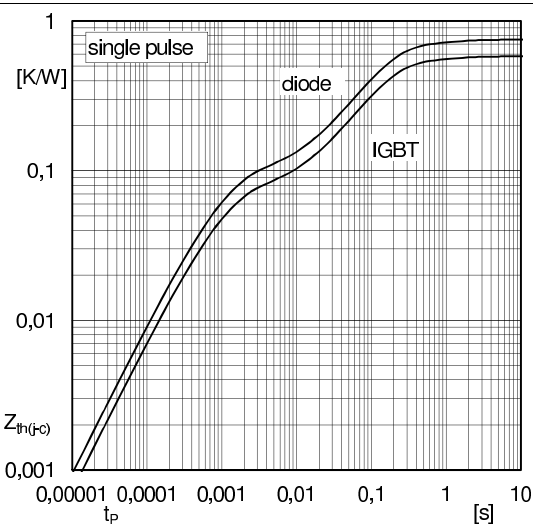


Fig. 9: Transient thermal impedance of IGBT and Diode

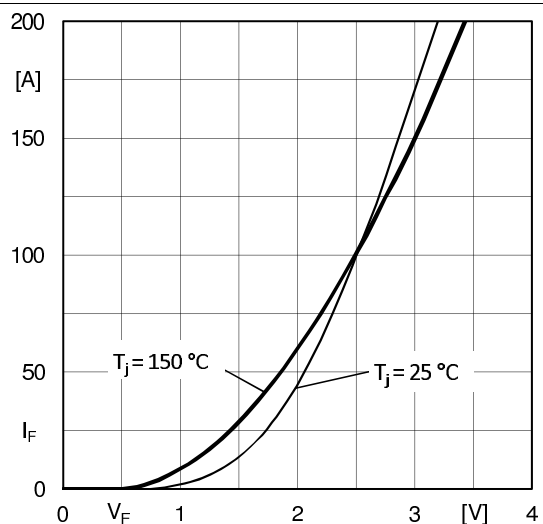


Fig. 10: CAL diode forward characteristic

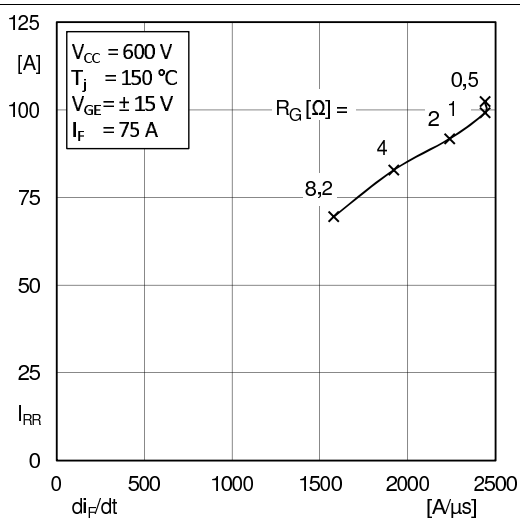


Fig. 11: Typ. CAL diode peak reverse recovery current

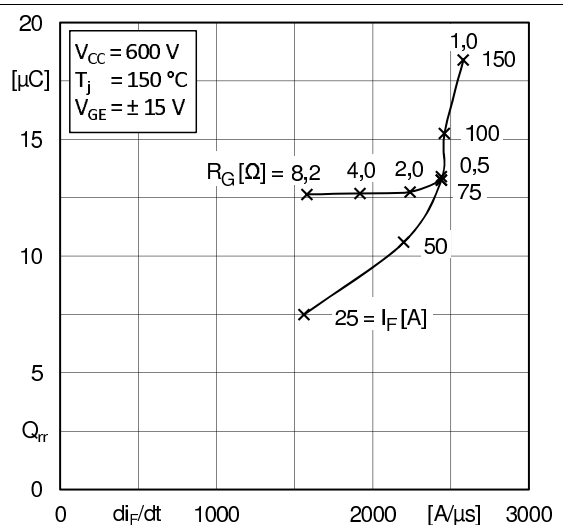


Fig. 12: Typ. CAL diode recovery charge



5